Total No. of Questions :4]		o. of Questions :4] SEAT No. :
P5		FE/Insem./APR-5 [Total No. of Pages : 1]
		F.E. (Semester - II)
		104010: BASIC ELECTRONICS ENGINEERING
		(2019 Pattern)
Time	:1	Hour] [Max. Marks: 30
		ions to the candidates:
	1) 2)	Answer Q.1 or Q.2, Q.3 or Q.4.
	<i>2)</i>	Assume suitable data if necessary.
Q 1)	a)	What is extrinsic semiconductor. Explain P-type & N-type
	•	semiconductor. [5]
	b)	Draw and Explain Half Wave Rectifier (HWR) with its corresponding input and output waveforms. [5]
	c)	Compare LED and Photodiode. [5]
	ĺ	OR OR
Q2)	a)	Define active and passive components Explain them with suitable
		examples. [5]
	b)	For full wave bridge rectifier, applied input voltage is 5sin wt. Calculate
	,	average output voltage, RMS voltage and PIV rating of diode used. [5]
	c)	Explain V-I characteristics of zener diode. [5]
(12)	۵)	Draw and avalain
<i>Q</i> 3)	a)	Draw and explain output characteristics of BJT in common emitter configuration. Show different regions of operation.
	b)	
	c)	For a Non - Inverting amplifier using op-amp if $R_f=20k\Omega$ and
		$R_1=1k-\Omega$, $V_{cc}=\pm 15V$. Calculate Output voltage for vin $=3V$ and
		comment on the result. [5]
		OR
Q4)	a)	Define transistor. Mention its types. For BJT, if $J_B = 20 \mu\text{A}$ and IE=2MA.
		Calculate value of Ic and β (Beta). [5]
	b)	Draw and Explain the drain characteristics of N-channel EMOSFET.
		Show the different regions of operation on the characteristics. [5]
	c)	Draw and explain functional block diagram of operational amplifier
		(op-amp). [5]
		8.
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		V°

Total No.	of Questions : 8]	
P6490	[Total No. of I	Pages: 2
1 0470		
	[5868]-106	
	F.E.	
	BASIC ELECTRONICS ENGINEERING	
<i>T</i> : 21	(2019 Pattern) (Semester - I & II) (104010)	1 70
	[Max. Ma ions to the candidates:	rks: 70
1 <i>nstructi</i> (1)	Solve Q.1 or Q.2, Q.3 or Q.4, Q.5 or Q.6, Q.7 or Q.8.	
2)	Neat diagrams must be drawn wherever necessary.	
3)	Figures to the right indicate full marks.	
4)	Use of logarithmic tables slide rule, Mollier charts, electronic calculator and steam tables is allowed.	pocket
5)	Assume suitable data if necessary.	
	6.	
Q1) a)	Convert	[6]
~ / /	i) (2BA.OC) ₁₆ to Octal.	
	$(462.27)_8 \text{ to Hexadecimal}$	
b) '	Why NAND and NOR are known as universal logic gates?	[6]
c)	Draw and explain block diagram of microprocessor.	[5]
- /	OR	[-,
Q2) a)	Perform the following arithmatic operations.	[5]
2 / "	i) (110011 – 111001) using 2's compliment method.	
	ii) (111011.11 + 100100.01)	
b)	State and prove Demorgon's Theorems.	[6]
c)	Draw and explain block diagram of microcontroller.	6
ς,	Diaw and explain or or intersectioner.	
Q3) a)	Explain principle of operation and block diagram Digital Multime	eter [6]
Q3) a) b)	Explain working of Auto-Transformer List its applications.	[6]
	11 () / 6.	
c)	Explain operation of DC Ammeter with suitable diagram. Explain	i circuii

or multi-range Ammeter. **[6]**

OR

Draw block diagram of function generator and explain functions of each **Q4**) a) block. **[6]**

Explain Digital storage oscilloscope. List its applications. **[6]** b)

Explain operation of DC voltmeter with suitable diagram. Explain circuit c) of multi-range voltmeter. **[6]**

Q5)	ŕ	Draw construction of LVDT and explain its operation. Write advantages, disadvantages and applications.	[6]			
	b)	Explain RTD with its construction, working, advantages, disadvanta and applications.	ges [6]			
	c)	Explain operation of Bio-sensor with one application. OR	[5]			
Q6)	a)	What are different types of transducers? Give one example of each ty	pe. [5]			
	b)	Explain working principle of strain guage. Explain load cell.	[6]			
	c)	Explain Thermocouple with its construction, working, advantage disadvantages and applications.	ges, [6]			
		Sp.				
Q 7)	a)	Explain different types of cables used in electronic communication.	[6]			
	b)	Draw and explain block diagram of FM transmitter.	[6]			
	c)	Draw and explain block diagram of GSM. OR	[6]			
Q 8)	a)	With the help of block diagram, explain operation of communicat system.	ion [6]			
	b)	Explain IEEE electromagnetic frequency spectrum and state allotment of frequency bands for different applications. [6]				
	c)	Explain block diagram of AM transmitter (High Power).	[6]			
		frequency bands for different applications. Explain block diagram of AM transmitter (High Power).				
[586	8]-	2 9				

Total	No.	[o. of Questions : 8] SEAT No. :	
P39	22	[Total No.	of Pages : 2
		[6001]-4006	
		E.E.	
		BASIC ELECTRONICS ENGINEERING	
		(2019 Pattern) (Semester - II) (104010)	
<i>a</i>	0.1/		1.5 1 50
		2½ Hours] [Max. tions to the candidates:	. <i>Marks</i> : 70
		Attempt Q.No.1 or Q.No.2, Q.No.3 or Q.No.4, Q.No.5 or Q.No.6, Q.No.	7 or Q.No.8.
2		Neat diograms must be drawn wherever necessary.	~
		Figures to the right indicate full marks.	
4	4)	Assume suitable data, if necessary.	
Q1)	a)	i) Convert:	
~		1) (372.26)8 to Hexadecimal	
	7	Assume suitable data, if necessary. i) Convert: 1) (372.26)8 to Hexadecimal 2) (5F1.6C) ₁₆ to Octal	
		3) (9D.33) ₁₆ to Decimal	
		ii) Solve:	
		1) (110011-111001) using 2s compliment method	
		2) (1101×110)	
		3) (111011.1(+100109.01	
			.[6]
		6.	
	b)	Define Universal Logic Gates. Why they known as Universal Logic Gates.	gic Gates?
			[6]
	c)) Draw block diagram of Microprocessor and explain function	on of each
		block.	[6]
		OR	
Q2)	a)	With the help of truth table, explain operation of AND, O	R, EX-OR
		gates.	[6]
	b)) State and prove De-Morgan's Theorems.	[6]
	c)		
	•	and give its sum and carry.	[6]
			[-3]
		8.	P.T.O.

Q 3)	a)	Explain digital multimeter with block diagram.	[6]
	b)	Explain Power Scope with block diagram.	[5]
	c)	Explain how to convert Galvarometer to Analog Voltmeter and how	v to
		use it as multi-range Voltmeter?	[6]
		OR OR	
Q4)	a)	Explain function Generator with block diagram.	[6]
~	b)	Explain Auto Transformer and list its applications.	[5]
	c)	Explain how to convert Galvanometer to Analog Ammeter and how	v to
		use it as multi-range Ammeter?	[6]
05)	۵)	Europa Dealection emitario of transducers	[7]
Q 5)	a)b)	Explain selection criteria of transducers. Draw construction of LVDT and explain its operation. Write	[6]
	U)	advantages, disadvantages and applications.	[6]
	c)	Explain working principle of strain gauge. Explain load cell.	[5]
		OR)	
Q6)	a)	Differentiate between active and passive sensors.	[6]
2-7	b)	Explain RTD with its construction, working, advantages, disadvanta	
	- /	and applications.	[6]
	c)	Explain operation of Biosensor with one application.	[5]
		6.2	
Q 7)	a)	With the help of block diagram, explain basic communication system	.[6]
	b)	Explain IEEE electromagnetic frequency spectrum and state allotmen	t of
		frequency bands for different applications.	[6]
	c)	Draw diagram explain GSM architecture.	[6]
		OR	
Q8)	a)	Explain different types of cables used in electronic communication.	[6]
~ .	b)	Draw block diagram of FM Transmitter and explain.	[6]
	c)	Explain cellular communication system.	[6]
	,		
		4006	
[ረ ሰሰ	117	4006	
լսսս	1]-	2	

Total No. of Questions: 8]			estions: 8]	SEAT No.:
P49	36			[Total No. of Pages : 2
			[5667] 1006	
			F.E. (Semester - I)	
			BASIC ELECTRONICS ENGIN	EERING
			(2019 Pattern)	
Time	e:	2½ He	ours]	[Max. Marks: 70
Instr	uct	ions to	the candidates:	
	1)	/	t diagrams must be drawn wherever necess	ary.
	2)		ures to right indicate full marks.	200
	<i>3</i>)	Assi	ame suitable data, if necessary.	
			6.	
Q1)	a)	()	e and prove De'Morgan's sum & produc	A- '
		trut	h table.	[6]
	b)	\ X	ign and implement full adder circuit. Wri	te the expressions for sum
		and	carry.	[6]
	c)	i)	Convert (105.15) ₁₀ to binary	
		ii)	Convert (4057.068) ₈ to decimal	
		iii)	Convert (1101101101101101) ₂ to hexad	decimal
		iv)	Find 1's complement of 111001	
		v)	Find (11100-01111) ₂ using two's comple	ment.
				(5]
			OR	S
Q2)	a)	Wh	at is flipflop? Draw & Explain the workin	g of clocked SR Flip flop.
			· · · · · · · · · · · · · · · · · · ·	[6]
	b)	Con	npare microprocessor and microcontrolle	er. [6]
	c)	Des	ign and Implement half adder circuit.	$\mathcal{O}' \mathcal{O}' $ [5]
Q3)	a)	Dra	w and Explain the block diagram of digital	multimeter. [6]
	b)	Exp	plain the block diagram of AC/DC power	supply. [6]
	c)	Exp	olain the working of function generator wit	h neat diagram. [6]

OR

<i>Q4</i>)	a)	Draw and explain the block diagram of digital storage oscilloscope.	[6]
	b)	Explain DC ammeter. Explain, how the range of DC ammeter can extended. Determine expression for shunt resistance.	n be [6]
	c)	Explain construction and working of an autotransformer.	[6]
Q 5)	a)	Explain the construction and working of LVDT.	[6]
	b)	Write a short note on two temperature transducers / sensors.	[6]
	c)	Explain the construction and working of load cell. Give one applicat	
		OR	[5]
Q6)	a)	Explain the working of biosensors with the help of neat block diag	ram
20)	u)	Give one application.	[6]
	b)	Draw and explain the working of accelerometer.	[6]
	c) '	An RTD is inserted in an oven is having a resistance 160Ω . At	0°C
		resistance is 100Ω and it's resistance temperature coefficient is 0.00 ?	392.
		Determine the change in temperature.	[5]
07)	۵)	Evaluin the block diagram of electronic communication system	[6]
Q 7)	a)	Explain the block diagram of electronic communication system.	[6]
	b)	Distinguish between co-axia cable and optical fiber cable.	[6]
	c)	Describe the block diagram of AM-transmitter.	[6]
		OR	.0
(18)	a)	Draw and explain electromagnetic spectrum along with their application	one
<i>Q8</i>)	a)	Draw and explain electromagnetic spectrum along with their applicati	[6]
	b)	Draw and explain the block diagram of FM receiver.	[6]
	c)	Diagramatically explain GSM architecture.	[6]

Total No. of Questions: 4]	95	SEAT No. :	7
P-5372		[Total No. of Pages :	1

[6185]-55

F.E. (Insem.)

BASIC ELECTRONICS ENGINEERING

(2019 Pattern) (Semester - I) (104010)

Time	: 1	[Max. Marks	: 30
Instr	uct	tions to the candidates:	
	1)	Attempt Q.1 or Q.2, Q.3 or Q.4.	
	<i>2</i>)	Figures to the right indicate full marks.	
Q1)	a)	Compare half wave rectifier and full wave rectifier.	[5]
	b)	Explain the construction and working principle of LED.	[5]
	c)	Explain impact of Electronics on society and industry.	[5]
		OR)	
Q 2)	a)	Compare active and passive components.	[5]
	b)	Explain the operation of bridge rectifier circuit with diagram.	[5]
	c)	Explain the construction and working of photodiode.	[5]
			ر کن
<i>Q3</i>)	a)	Draw an explain input and output characteristics of BJT in com-	mon
~		emitter configuration, show different regions of operation.	[5]
	b)	Compare BJT and MOSFET.	[5]
	c)	Draw and explain Internal Block diagram of OP-AMP.	[5]
		OR OF	
Q4)	a)	Explain with suitable diagram operation of NPN transistor	[5]
	b)	Explain construction and operation of n-channel E-MOSFET.	[5]
	c)	State and explain practical parameters of OP-AMP.	[5]

Total No. of Questions : 4]	200	SEAT No.:	
P1273		[Total	No. of Pages : 2
	OCT/FE/INSEM/-6		

F.E. (Semester - I)						
	BASIC ELECTRONICS ENGINEERING					
			(2019 Pattern)			
Time	e: 1	Hour		Max. Marks : 30		
			the candidates;			
	1)	Ans	wer Q,1 or Q,2, Q.3 or Q.4			
	<i>2</i>)	Figi	are to right indicate full marks.			
<i>Q1</i>)	a)	Cor	mpare active and passive components explain passive	components.[5]		
	b)	Exp	plain the operation of full wave Rectifier with suitab	ole diagram and		
	,	. 7	ve forms.	[5]		
	c)	×Exr	plain the construction and working principle of LED.	[5]		
	-,	·		[-]		
			OR			
Q 2)	a)	Exp	plain impact of electronics on Industry.	[5]		
	b)	Exp	plain the construction and working of = P - N junction	diode. Draw its		
		V -	I characteristics	[5]		
	c)	Dra	w circuit diagram of zener diode as voltage regulator	and Explain 🙀		
	<i>C)</i>	Dia	we circuit diagram of concr diode as voltage regulator	[5]		
			%. · ·			
Q 3)	a)	Dra	w and explain BJT as a switch.	[5]		
23)	ĺ			70.		
	b)	Exp	plain construction and operation of N - channel EMO	Ξ'		
	c)		inverting amplifier using op = Amp, if $R_r = 100 \text{ K}\Omega$, $10V$, $V_i = 2V$	$\dot{R}_1 = 10 K\Omega, V_{CC}$		
		i)	Calcalate output voltage.			
		ii)	Is the result in part (i) practically possible? Justify.	[5]		
			OR OR			

- Explain construction of BJT with respect to area and doping **Q4**) a) concentration. Mention the types of BJT. [5]
 - Explain construction and operation of p channel EMOSFET. [5]
 - Write ideal and practical values of five parameters of op-Amp. [5]

and operation practical values of a second s And the state of t

Total No	. of Questions : 4]	00	SEAT No. :
PA-16	583 [5931]-	1006	[Total No. of Pages : 2
	First Year (Ĕ	ngineering	<u>(</u>)
	BASIC ELECTRONIC	CS ENGIN	EERING
	(2019 Pattern) (Sem	ester - I) (104010)
<i>Time</i> : 1	Hour]		[Max. Marks : 30
Instruction	ons to the condidates:		
1)	Attempt Q.1 or Q.2 and Q.3 or Q.4.		
2)	Figures to the right indicate full mark	ks.	9-
<i>3</i>)	Assume suitable data, wherever neces	sary.	
4)	Use of electronic pocket calculator is	allowed.	
O(1)	How electronic components of	ra cotagari	caddin active and passive

- electronic components are categorised in active and passive **Q1**) a) components and compare them. [5]
 - b) Draw and explain V-I characteristics of P-M Junction Diode and define these parameters. [5]
 - i) Cut-in Voltage
 - **PIV** ii)
 - Reverse safuration current iii)
 - Explain how Zener Diode can be used as voltage regulator. c)

- Explain impact of electronics on industry and society. **Q2**) a)
 - Explain working of Bridge Rectifier circuit with the help of wave forms.[5] b)
 - oltage Oltage Determine the minimum and maximum input voltage for which zener c) Diode works as voltage regulator, [5]

For zener assume

Iz (min) = 1 MA

Iz (max) 10 MA

$$Zz = 0-\Omega Vz = 5V$$

and RL = $1K\Omega$ Rs = 470Ω

Draw output characteristics of BJT in common Emitter configaration. **Q3**) a) Indicate different operating regions in it. Draw circuit diagram of single stage E-MOSFET amplifier in common b) source configuration and explain functions of each component used in it. [5] Draw and explain functional black diagram of operational amplifier. [5] c) OR Draw circuit diagram of single stage BJT amplifier in common emitter **Q4**) a) configuration and explain function of each components. Explain working of N-channel E-MOSFET with the help of its b) construction. [5] Define following parameters of op-amp and mention their ideal and c) practical values. [5] **CMRR Input Bias Current** Input offset voltage iii) Slew Rate iv) V) **PSRR**